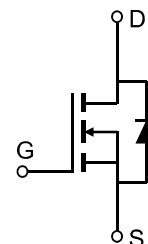


Description

Features

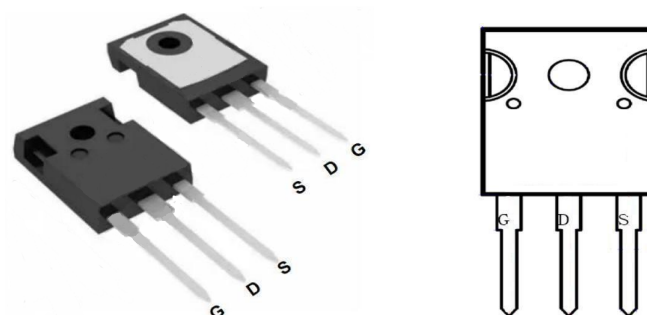
- 650V, 24A
 $R_{DS(ON)}$ Typ = 130mΩ@ $V_{GS} = 10V$
- It has been designed to low on-state resistance and high frequency
- Fast reverse recovery body diode
- Low $R_{DS(ON)}$
- Ultra-low on-resistance



Schematic Diagram

Application

- SMPS
- Adapter
- LED lighting
- TV Power Supply



Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	TUBE (pcs)	InnerBox (pcs)	Per Carton (pcs)
CN33N60M2	CX130RN65H	TO-247-3L	TUBE	30	450	2250

Absolute Maximum Ratings (@ $T_J=25^{\circ}C$ unless otherwise specifie)

Symbol	Parameter		Value	Units
V_{DS}	Drain-Source Voltage		650	V
I_D	Continuous drain current ^(Note 1)	$T_C = 25^{\circ}C$ $T_C = 100^{\circ}C$	24 14.4	A
I_{DM}	Drain Current - Pulsed ^(Note 2)		96	A
E_{AS}	Single Pulsed Avalanche Energy ^(Note 3)		361	mJ
V_{GS}	Gate source voltage		±20	V
P_D	Power Dissipation	$T_C = 25^{\circ}C$	241	W
T_J, T_{stg}	Operating and Storage temperature		-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Value	Units
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Steady State	60	$^{\circ}\text{C/W}$
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Steady-State	0.52	$^{\circ}\text{C/W}$

Electrical Characteristics($T_J=25^{\circ}\text{C}$ unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
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Off Characteristics

B_{VDSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	650	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 650\text{ V}, V_{GS} = 0\text{ V}$	-	-	1.0	μA
I_{GSS}	Gate-Body Leakage Current	$V_{DS} = 0\text{ V}, V_{GS} = \pm 30\text{ V}$	-	-	± 100	nA

On Characteristics

$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	3	3.5	4	V
$R_{DS(ON)}$	Static Drain-Source ON-Resistance	$V_{GS} = 10\text{ V}, I_D = 5\text{ A}$	-	130	156	m Ω

C_{iss}	Input Capacitance	$V_{GS} = 0\text{ V}, V_{DS} = 50\text{ V},$ $F = 1\text{ MHz}$	-	1354	-	pF
C_{oss}	Output Capacitance		-	107	-	pF
C_{rss}	Reverse Transfer Capacitance		-	9.0	-	pF
Q_g	Total Gate Charge	$V_{DD} = 400\text{ V}, I_D = 15\text{ A},$ $V_{GS} = 0\text{ to }10\text{ V}$	-	16	-	nC
Q_{gs}	Gate Source Charge		-	6	-	nC
Q_{gd}	Gate Drain Charge		-	6.9	-	nC

Switching Characteristics

$t_{d(on)}$	Turn-On DelayTime	$V_{DD} = 400\text{ V}$	-	51	-	ns
t_r	Turn-On Rise Time	$V_{GS} = 10\text{ V}$	-	19	-	ns
$t_{d(off)}$	Turn-Off DelayTime	$I_D = 15\text{ A}$	-	53	-	ns
t_f	Turn-Off Fall Time	$R_G = 5\text{ }\Omega$	-	15.8	-	ns

Diode Recovery Characteristics

I_S	Continuous Source Current (Body Diode)		-	-	24	A
I_{SM}	Pulsed Source Current (Body Diode)		-	-	72	A
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0\text{ V}, I_S = 15\text{ A}$	-	0.8	1.2	V
t_{rr}	Body Diode Reverse Recovery Time		-	223	-	ns
Q_{rr}	Body Diode Reverse Recovery Charge	$V_R = 400\text{ V}, I_F = 15\text{ A},$ $di/dt = 100\text{ A/us}$	-	4.4	-	μC
I_{rrm}	Peak reverse recovery current		-	27	-	A

- Notes:
- 1.The max drain current rating is junction temperature limited
 2. Repetitive Rating: Pulse width limited by maximum junction temperature
 3. E_{AS} condition: Starting $T_J=25^{\circ}\text{C}$, $V_{DD}=100\text{ V}$, $V_G=10\text{ V}$, $R_G=25\text{ ohm}$, $L=10\text{ mH}$, $I_{AS}=8.5\text{ A}$

Test Circuit

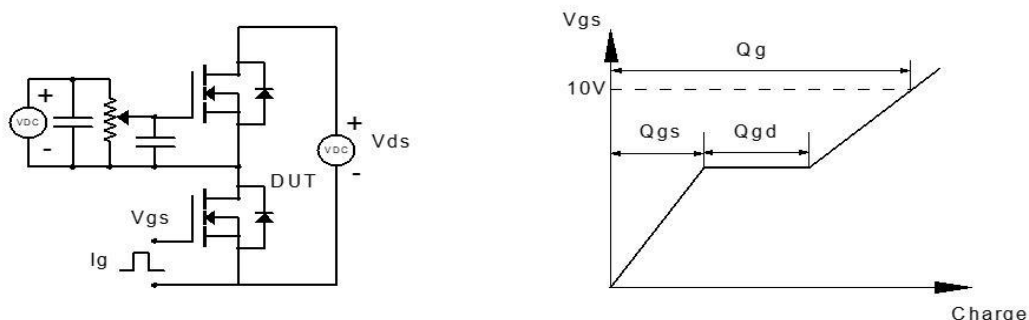


Figure 1: Gate Charge Test Circuit & Waveform

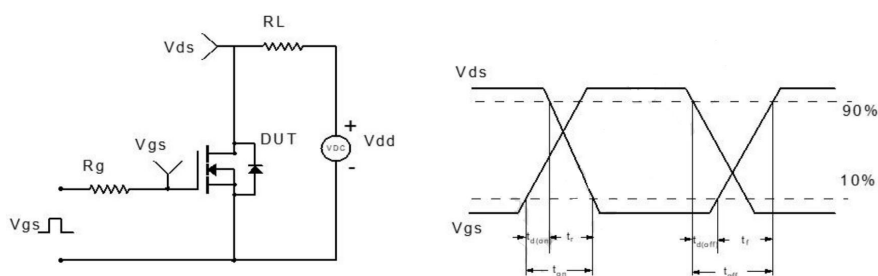


Figure 2: Resistive Switching Test Circuit & Waveform

Figure 2: Resistive Switching Test Circuit & Waveform

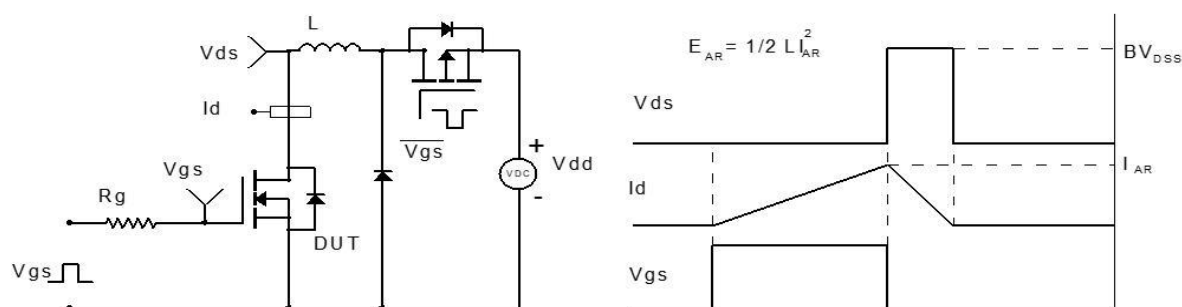


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

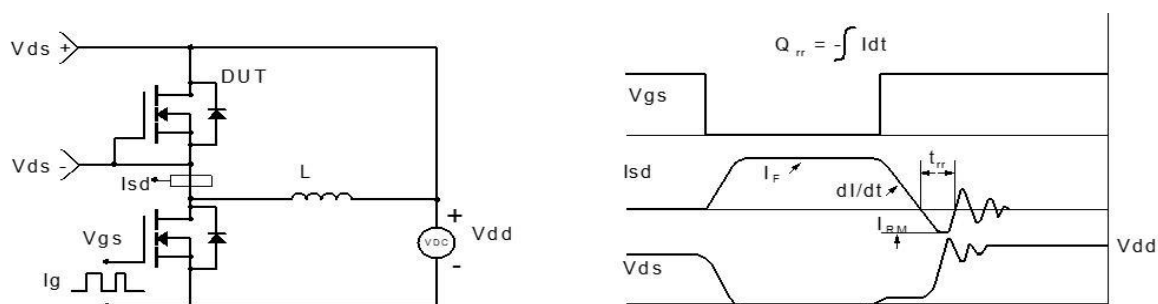
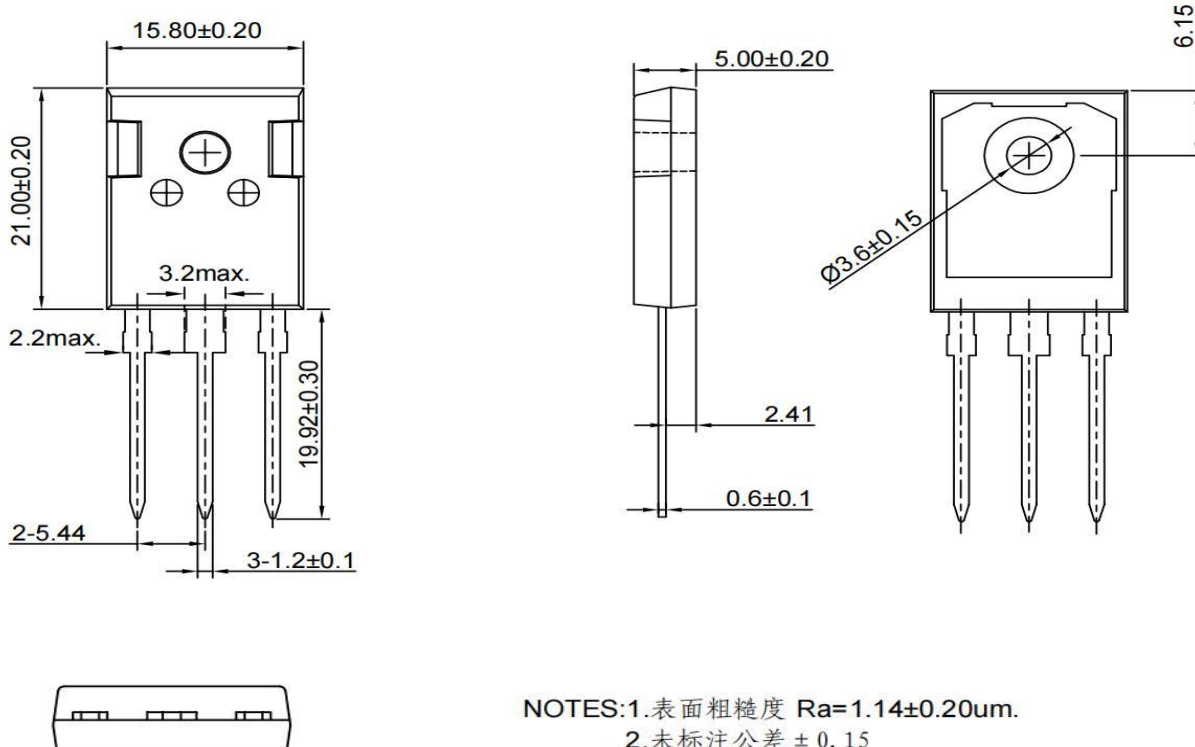


Figure 4: Diode Recovery Test Circuit & Waveform

Package Mechanical Data(TO-247-3L)



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